

MCP809/810

1.0 ELECTRICAL CHARACTERISTICS

1.1 Maximum Ratings*

V_{DD} 7.0V
 All inputs and outputs w.r.t. V_{SS} -0.6V to V_{DD} +1.0V
 Storage temperature -65°C to +150°C
 Ambient temp. with power applied -65°C to +125°C
 ESD protection on all pins ≥ 2 kV

***Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC AND AC CHARACTERISTICS

All parameters apply at the specified temp and voltage ranges unless otherwise noted.		V _{DD} = 1.0 - 5.5V Industrial (I): -40°C to +85°C					
Parameter		Symbol	Min.	Typ.	Max.	Units	Test Conditions
Operating Voltage Range		V _{DD}	1.0	—	5.5	V	
V _{DD} Value to RESET/RESET		V _{DDMIN}	1.0	—	—	V	
Operating Current		I _{DD}	—	45	60	μA	V _{DD} = 5.5V (no load)
V _{DD} Trip Point	MCP8XX-270	V _{TRIP}	2.55	2.625	2.7	V	
	MCP8XX-300		2.85	2.925	3.0		
	MCP8XX-315		3.0	3.075	3.15		
	MCP8XX-450		4.25	4.375	4.50		
	MCP8XX-460		4.35	4.475	4.60		
	MCP8XX-475		4.50	4.625	4.75		
	MCP8XX-485		4.60	4.725	4.85		
RESET Low Level Output Voltage (MCP809)	MCP809-270 MCP809-300 MCP809-315	V _{OL}	—	—	0.4	V	I _{OL} = 3.2 mA, V _{DD} = V _{TRIP} _{MIN}
	MCP809-450 MCP809-460 MCP809-475 MCP809-485		—	—	0.6		I _{OL} = 8.5 mA, V _{DD} = V _{TRIP} _{MIN}
RESET High Level Output Voltage (MCP809)	MCP809-xxx (All V _{TRIP} Points)	V _{OH}	V _{DD} -0.7	—	—	V	I _{OH} = 3 mA, V _{DD} > V _{TRIP} _{MAX}
RESET Low Level Output Voltage (MCP810)	MCP810-270 MCP810-300 MCP810-315	V _{OL}	—	—	0.4	V	I _{OL} = 3.2 mA, V _{DD} > V _{TRIP} _{MAX}
	MCP810-450 MCP810-460 MCP810-475 MCP810-485		—	—	0.6		I _{OL} = 8.5 mA, V _{DD} > V _{TRIP} _{MAX}
RESET High Level Output Voltage (MCP810)	MCP810-xxx (All V _{TRIP} Points)	V _{OH}	V _{DD} -0.7	—	—	V	I _{OH} = 3 mA, V _{DD} = V _{TRIP} _{MIN}
Threshold Hysteresis		V _{HYS}	—	50	—	mV	
V _{DD} Detect to RESET/RESET Inactive		t _{RPU}	150	350	700	ms	
V _{DD} Detect to RESET/RESET		t _{RPD}	—	10	—	μs	V _{DD} ramped from V _{TRIP} _{MAX} + 250 mV down to V _{TRIP} _{MIN} - 250 mV

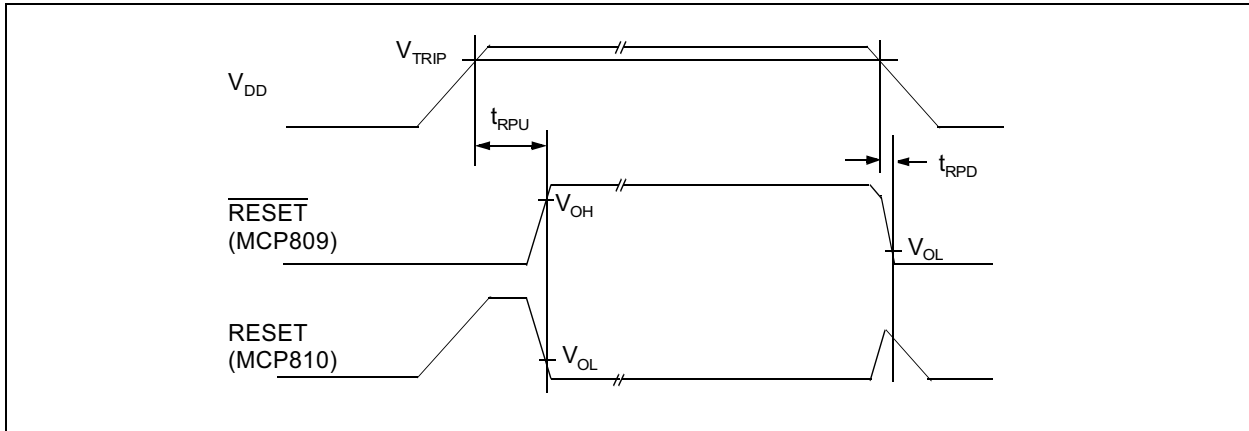


FIGURE 1-1: MCP809/810 TIMING DIAGRAM

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2.0 APPLICATIONS INFORMATION

2.1 The Need for Supervisory Circuits

For many of today's microcontroller applications, care must be taken to prevent low power conditions that can cause many different system problems. The most common causes are brown-out conditions where the system supply drops below the operating level momentarily, and the second, is when a slowly decaying power supply causes the microcontroller to begin executing instructions without enough voltage to sustain SRAM and producing indeterminate results.

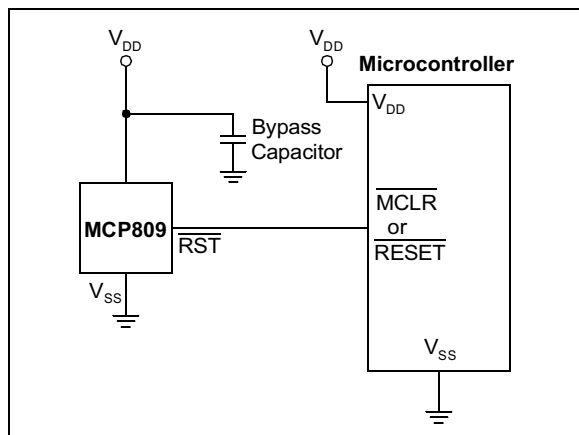


FIGURE 2-1: TYPICAL APPLICATION

2.2 Negative Going V_{DD} Transients

Many system designers implementing POR circuits are concerned about the minimum pulse width required to cause a reset. Figure shows typical transient duration vs. reset comparator overdrive for which the MCP809/810 will not generate a reset pulse. It shows that the farther below the trip point the transient pulse goes, the duration of the pulse required to cause a reset gets shorter. A 0.1 μF bypass cap mounted as close as possible to the V_{DD} pin provides additional transient immunity.

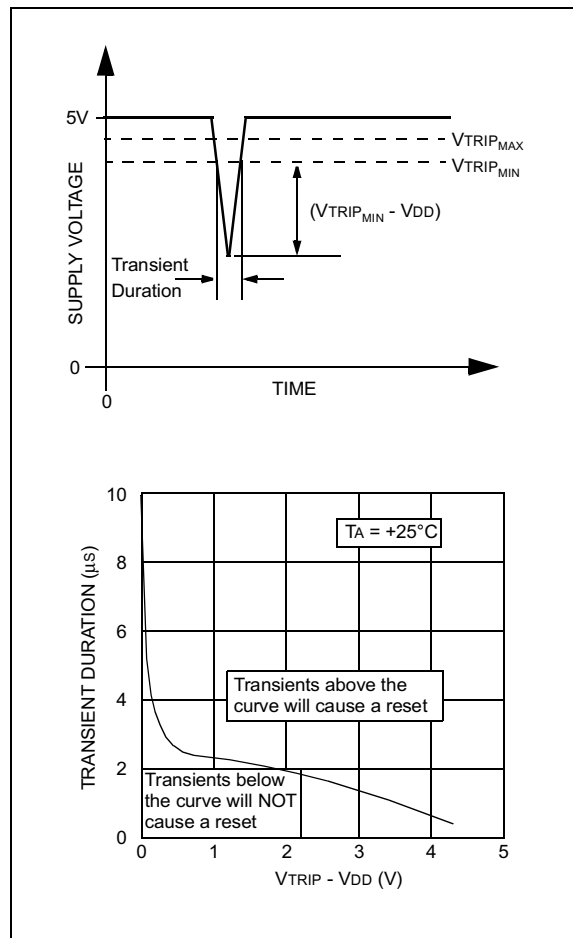


FIGURE 2-2: TYPICAL TRANSIENT RESPONSE

Effect of Temperature on Timeout Period (t_{RPU})

The timeout period (t_{RPU}) determines how long the device remains in the reset condition. This is controlled by an internal RC timer and is effected by both V_{DD} and temperature. The graph shown in Figure 2-3 shows typical response for different V_{DD} values and temperatures.

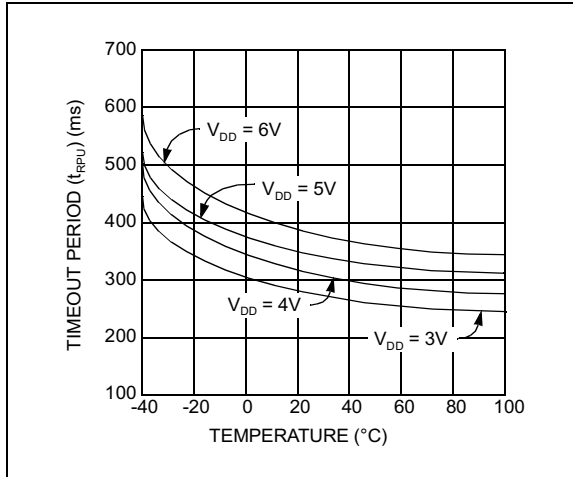


FIGURE 2-3: TYPICAL T_{RPU} VS. TEMPERATURE

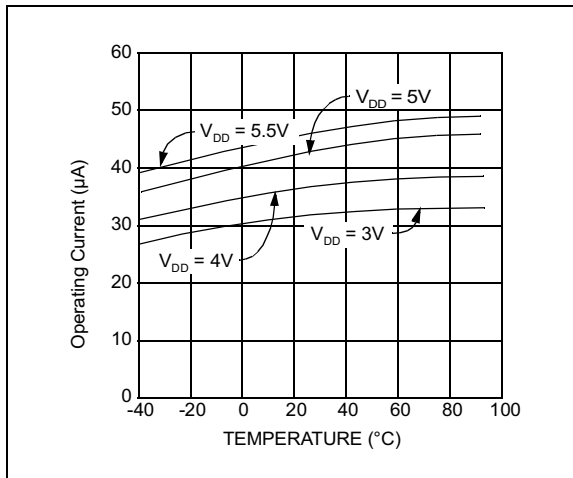


FIGURE 2-4: I_{DD} VS. TEMPERATURE

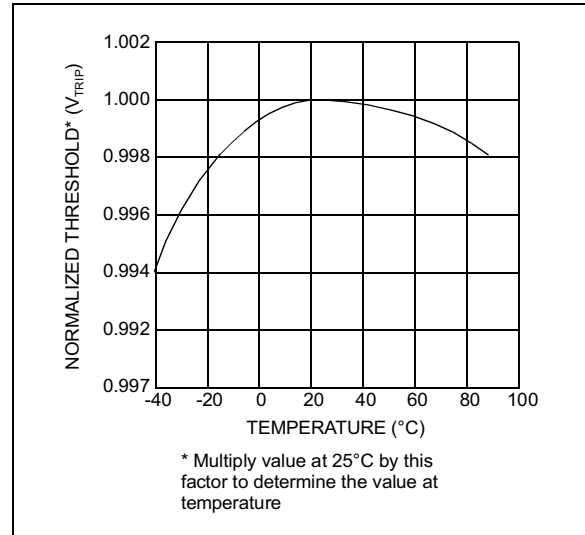


FIGURE 2-5: NORMALIZED V_{TRIP} VS. TEMPERATURE

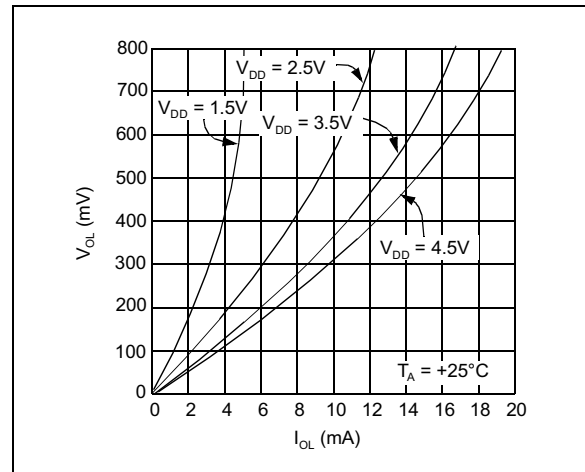


FIGURE 2-6: V_{OL} VS. I_{OL}

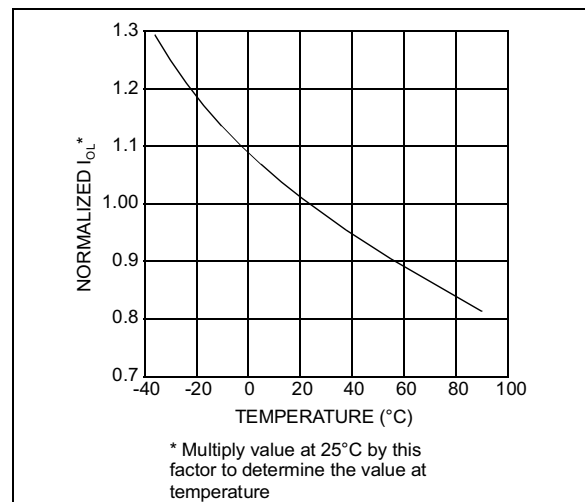


FIGURE 2-7: NORMALIZED I_{OL} vs. TEMPERATURE

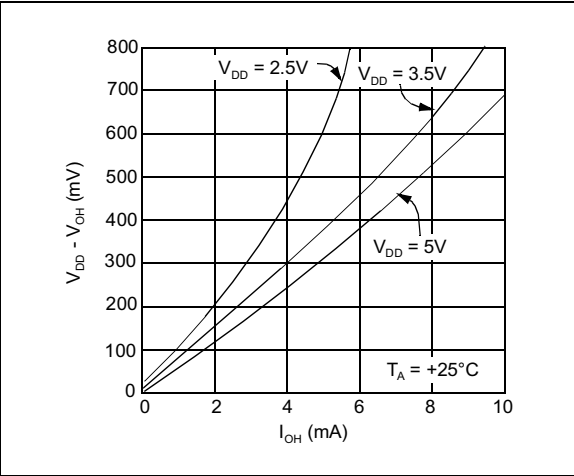


FIGURE 2-8: $V_{DD} - V_{OH}$ vs. I_{OH}

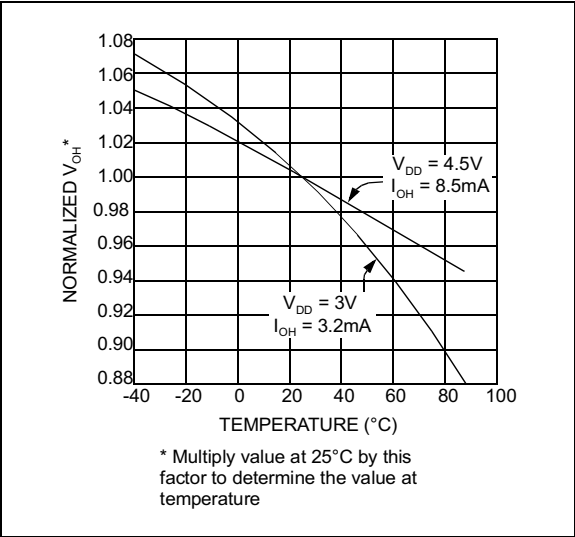


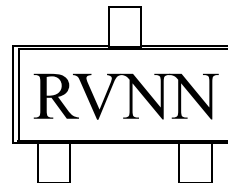
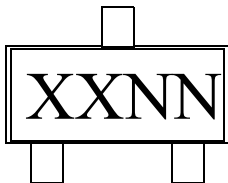
FIGURE 2-9: NORMALIZED V_{OH} vs. TEMPERATURE

3.0 PACKAGING INFORMATION

3.1 Package Marking Information

3-Lead Plastic Small Outline Transistor (SOT23)

Example:



SOT23 PARTS LABELING:

The table below identifies the first 2 characters (XX) in the 4-character field (XXNN) for marking of the 3-Lead SOT23 package.

Mark	Part Number	Mark	Part Number
QR	MCP809T-270I/TT	RR	MCP810T-270I/TT
QS	MCP809T-300I/TT	RS	MCP810T-300I/TT
QT	MCP809T-315I/TT	RT	MCP810T-315I/TT
QU	MCP809T-450I/TT	RU	MCP810T-450I/TT
QV	MCP809T-460I/TT	RV	MCP810T-460I/TT
QW	MCP809T-475I/TT	RW	MCP810T-475I/TT
QZ	MCP809T-485I/TT	RZ	MCP810T-485I/TT

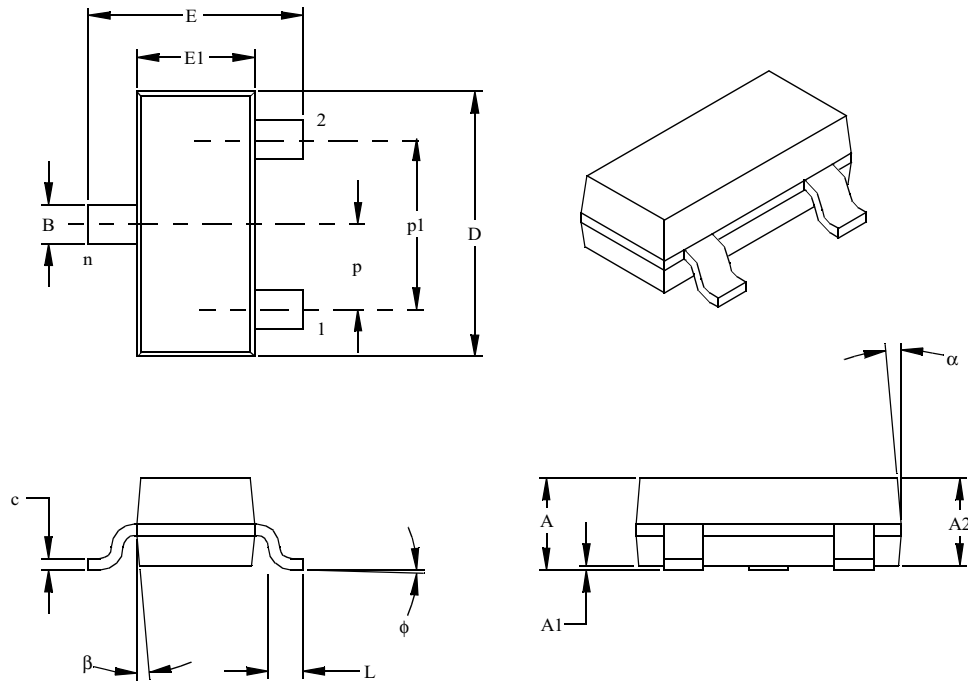
Legend:	XX...X	Customer specific information*
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.	

- * Standard OTP marking consists of Microchip part number, year code, week code, and traceability code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

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3.2 Package Detail Information

3-Lead Plastic Small Outline Transistor (TT) (SOT23)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		3			3	
Pitch	p		.038			0.96	
Outside lead pitch (basic)	p1		.076			1.92	
Overall Height	A	.035	.040	.044	0.89	1.01	1.12
Molded Package Thickness	A2	.035	.037	.040	0.88	0.95	1.02
Standoff §	A1	.000	.002	.004	0.01	0.06	0.10
Overall Width	E	.083	.093	.104	2.10	2.37	2.64
Molded Package Width	E1	.047	.051	.055	1.20	1.30	1.40
Overall Length	D	.110	.115	.120	2.80	2.92	3.04
Foot Length	L	.014	.018	.022	0.35	0.45	0.55
Foot Angle	φ	0	5	10	0	5	10
Lead Thickness	c	.004	.006	.007	0.09	0.14	0.18
Lead Width	B	.015	.017	.020	0.37	0.44	0.51
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

* Controlling Parameter

§ Significant Characteristic

Note:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: TO-236

Drawing No. C04-104

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013001

PRODUCT IDENTIFICATION SYSTEM

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<u>PART NO.</u>	<u>X</u>	<u>X</u>	<u>/XX</u>
Device	RESET/ RESET V _{TRIP} Voltage	Temperature Range	Package
Device:	MCP809T: Supervisory circuit with active low $\overline{\text{RESET}}$ output (tape & reel) MCP810T: Supervisory circuit with active high $\overline{\text{RESET}}$ output (tape & reel)		
RESET/RESET V _{TRIP} Voltage:	270 = $2.55 \leq V_{\text{TRIP}} \leq 2.70$ 300 = $2.85 \leq V_{\text{TRIP}} \leq 3.00$ 315 = $3.00 \leq V_{\text{TRIP}} \leq 3.15$ 450 = $4.25 \leq V_{\text{TRIP}} \leq 4.50$ 460 = $4.35 \leq V_{\text{TRIP}} \leq 4.60$ 475 = $4.50 \leq V_{\text{TRIP}} \leq 4.75$ 485 = $4.60 \leq V_{\text{TRIP}} \leq 4.85$		
Temperature Range:	I = -40°C to +85°C		
Package:	TT = SOT-23 (3 lead) (offered in tape & reel only)		

Examples:

- MCP809T-270I/TT = Tape & Reel, V_{TRIP} range of 2.55V - 2.70V, Industrial Temp., SOT-23 package
- MCP810T-300/TT = Tape & Reel, V_{TRIP} range of 2.85V - 3.00V, Industrial Temp., SOT-23 package

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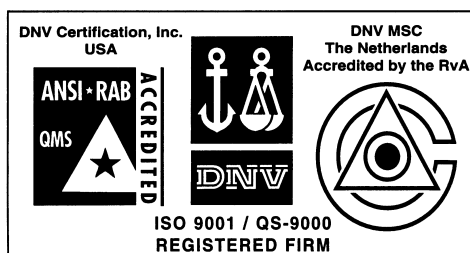
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